- **Package Options Include Plastic Small-Outline (D) Thin Shrink Small-Outline (PW), and Ceramic Flat (W) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) DIPs**

SN54HC86 . . . J OR W PACKAGE
SN74HC86 . . . D, N, OR PW PACKAGE
(TOP VIEW)

```
        ___ ___
1A [ 1        14 ] V_CC
1B [ 2        13 ] 4B
1Y [ 3        12 ] 4A
2A [ 4        11 ] 4Y
2B [ 5        10 ] 3B
2Y [ 6         9 ] 3A
GND [ 7        8 ] 3Y
```

description

These devices contain four independent 2-input exclusive-OR gates. They perform the Boolean function $Y = A \oplus B$ or $Y = \overline{A}B + A\overline{B}$ in positive logic.
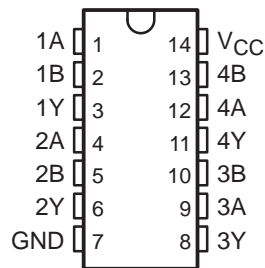
A common application is as a true/complement element. If one of the inputs is low, the other input is reproduced in true form at the output. If one of the inputs is high, the signal on the other input is reproduced inverted at the output.

The SN54HC86 is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74HC86 is characterized for operation from –40°C to 85°C.
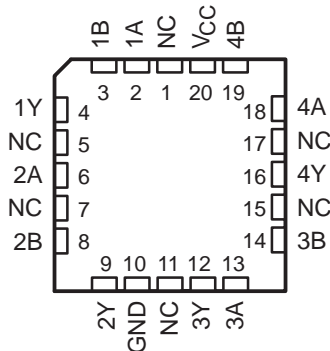
SN54HC86 . . . FK PACKAGE
(TOP VIEW)

```
        1B 1A NC V_CC 4B
         3  2  1  20 19
1Y [ 4              18 ] 4A
NC [ 5              17 ] NC
2A [ 6              16 ] 4Y
NC [ 7              15 ] NC
2B [ 8              14 ] 3B
         9 10 11 12 13
        2Y GND NC 3Y 3A
```

NC – No internal connection

FUNCTION TABLE
(each gate)

INPUTS		OUTPUT
A	**B**	**Y**
L	L	L
L	H	H
H	L	H
H	H	L

logic symbol[†]
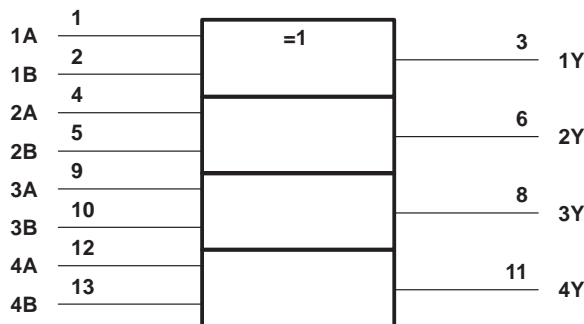
[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.
Pin numbers shown are for the D, J, N, PW, and W packages.

TEXAS INSTRUMENTS

exclusive-OR logic

An exclusive-OR gate has many applications, some of which can be represented better by alternative logic symbols.

Exclusive OR

These are five equivalent exclusive-OR symbols valid for an 'HC86 gate in positive logic; negation may be shown at any two ports.

Logic Identity Element **Even-Parity Element** **Odd-Parity Element**

The output is active (low) if all inputs stand at the same logic level (i.e., A = B).

The output is active (low) if an even number of inputs (i.e., 0 or 2) are active.

The output is active (high) if an odd number of inputs (i.e., only 1 of the 2) are active.

absolute maximum ratings over operating free-air temperature range[†]

Supply voltage range, V_{CC} .... –0.5 V to 7 V
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$) (see Note 1) .... ±20 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$) (see Note 1) .... ±20 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC}) .... ±25 mA
Continuous current through V_{CC} or GND .... ±50 mA
Package thermal impedance, θ_{JA} (see Note 2): D package .... 127°C/W
                                                   N package .... 78°C/W
                                                   PW package .... 170°C/W
Storage temperature range, T_{stg} .... –65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
        2. The package thermal impedance is calculated in accordance with JESD 51, except for through-hole packages, which use a trace length of zero.

recommended operating conditions (see Note 3)

			SN54HC86			SN74HC86			UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage		2	5	6	2	5	6	V
V_{IH}	High-level input voltage	V_{CC} = 2 V	1.5			1.5			V
		V_{CC} = 4.5 V	3.15			3.15			
		V_{CC} = 6 V	4.2			4.2			
V_{IL}	Low-level input voltage	V_{CC} = 2 V	0		0.5	0		0.5	V
		V_{CC} = 4.5 V	0		1.35	0		1.35	
		V_{CC} = 6 V	0		1.8	0		1.8	
V_I	Input voltage		0		V_{CC}	0		V_{CC}	V
V_O	Output voltage		0		V_{CC}	0		V_{CC}	V
t_t	Input transition (rise and fall) time	V_{CC} = 2 V	0		1000	0		1000	ns
		V_{CC} = 4.5 V	0		500	0		500	
		V_{CC} = 6 V	0		400	0		400	
T_A	Operating free-air temperature		–55		125	–40		85	°C

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

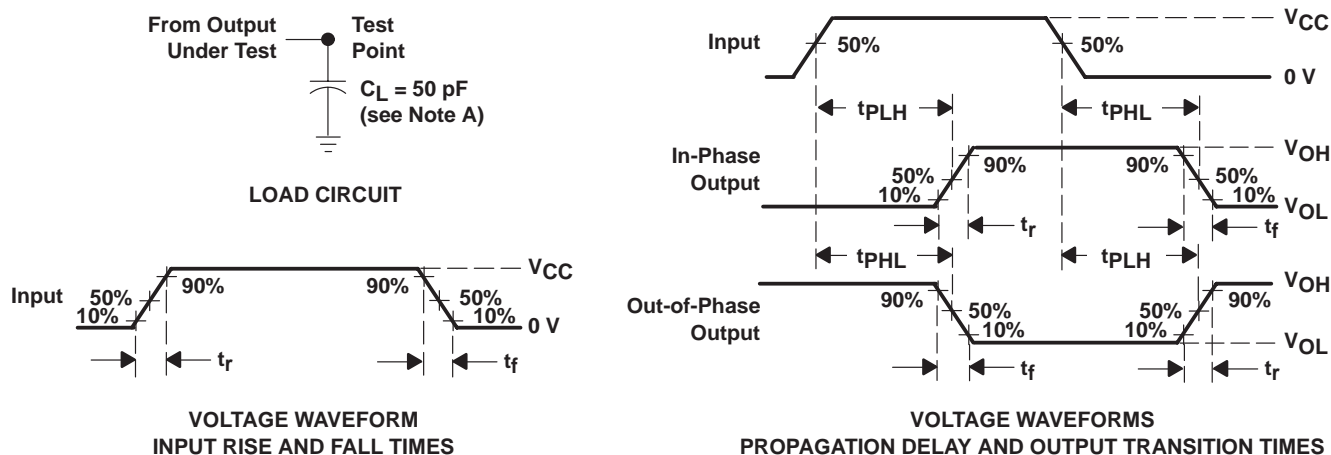| PARAMETER	TEST CONDITIONS		V_{CC}	T_A = 25°C			SN54HC86		SN74HC86		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
V_{OH}	V_I = V_{IH} or V_{IL}	I_{OH} = −20 µA	2 V	1.9	1.998		1.9		1.9		V
			4.5 V	4.4	4.499		4.4		4.4		
			6 V	5.9	5.999		5.9		5.9		
		I_{OH} = −4 mA	4.5 V	3.98	4.3		3.7		3.84		
		I_{OH} = −5.2 mA	6 V	5.48	5.8		5.2		5.34		
V_{OL}	V_I = V_{IH} or V_{IL}	I_{OL} = 20 µA	2 V		0.002	0.1		0.1		0.1	V
			4.5 V		0.001	0.1		0.1		0.1	
			6 V		0.001	0.1		0.1		0.1	
		I_{OL} = 4 mA	4.5 V		0.17	0.26		0.4		0.33	
		I_{OL} = 5.2 mA	6 V		0.15	0.26		0.4		0.33	
I_I	V_I = V_{CC} or 0		6 V		±0.1	±100		±1000		±1000	nA
I_{CC}	V_I = V_{CC} or 0, I_O = 0		6 V			2		40		20	µA
C_i			2 V to 6 V		3	10		10		10	pF

TEXAS
INSTRUMENTS

switching characteristics over recommended operating free-air temperature range, C_L = 50 pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V_{CC}	T_A = 25°C			SN54HC86		SN74HC86		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t_{pd}	A or B	Y	2 V		40	100		150		125	ns
			4.5 V		12	20		30		25	
			6 V		10	17		25		21	
t_t		Y	2 V		28	75		110		95	ns
			4.5 V		8	15		22		19	
			6 V		6	13		19		16	

operating characteristics, T_A = 25°C

PARAMETER	TEST CONDITIONS	TYP	UNIT
C_{pd} Power dissipation capacitance per gate	No load	35	pF

PARAMETER MEASUREMENT INFORMATION

LOAD CIRCUIT

**VOLTAGE WAVEFORM
INPUT RISE AND FALL TIMES**

**VOLTAGE WAVEFORMS
PROPAGATION DELAY AND OUTPUT TRANSITION TIMES**

NOTES: A. C_L includes probe and test-fixture capacitance.
         B. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: PRR ≤ 1 MHz, Z_O = 50 Ω, t_r = 6 ns, t_f = 6 ns.
         C. The outputs are measured one at a time with one input transition per measurement.
         D. t_{PLH} and t_{PHL} are the same as t_{pd}.

Figure 1. Load Circuit and Voltage Waveforms

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